

# Conductometric Gas Sensors based on Nanostructured WO<sub>3</sub> Thin Films

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**Abstract**—Nanostructured WO<sub>3</sub> thin films have been prepared by thermal evaporation to detect hydrogen at low temperatures. The influence of heat treatment on the physical, chemical and electronic properties of these films has been investigated. The films were annealed at 400°C for 2 hours in air. AFM and TEM analysis revealed that the as-deposited WO<sub>3</sub> film is high amorphous and made up of cluster of particles. Annealing at 400°C for 2 hours in air resulted in very fine grain size of the order of 5 nm and porous structure. GIXRD and Raman analysis revealed that annealing improved the crystallinity of WO<sub>3</sub> film. Gas sensors based on annealed WO<sub>3</sub> films have shown a high response towards various concentrations (10-10000 ppm) H<sub>2</sub> at an operating temperature of 150°C. The improved sensing performance at low operating temperature is due to the optimum physical, chemical and electronic properties achieved in the WO<sub>3</sub> film through annealing.

**Keywords**—nanostructured; thin films; WO<sub>3</sub>; thermal evaporation; annealing.

## I. INTRODUCTION

Gas sensors operate on the principle of conversion of gas concentration into a measurable signal. Gas sensor devices that have been developed so far include mass sensitive sensors, optical sensors, electrolytic sensors and solid state sensors [1]. Among the solid-state gas sensors, semiconductor metal oxide gas sensors have received the most attention as they show good potential for continuous monitoring of gases. These sensors offer a wide variety of advantages over the traditional analytical instruments which include lower cost, easier manufacturing, smaller size, short response and faster recovery. Semiconductor metal oxide material such as tungsten oxide (WO<sub>3</sub>) has shown great potential for gas sensing due to its inherent electrical conductivity and excellent sensitivity towards various gases. Low fabrication costs combined with low power consumption and a promise of high gas sensitivity towards specific gases are the driving force behind research on WO<sub>3</sub> for improved gas sensing properties. However, as for any other metal oxide based gas sensor, WO<sub>3</sub> based gas sensors operate efficiently only in the temperature range 200°C-500°C [2].

The gas sensing mechanism is based on bulk resistance changes of the WO<sub>3</sub> film induced by reactions between the target gases and the film surface. In air environment, oxygen molecules adsorb onto the surface of metal oxide layer to form

O<sub>2</sub><sup>-</sup>, O<sup>-</sup> and O<sup>2-</sup> species by extracting electrons from the conduction band depending on the temperature [3] and type of metal oxide (n-type or p-type). For n-type sensor material like WO<sub>3</sub> and a reducing gas, gas reacts with oxygen ions to form neutral molecules, leading to electron transfer to the sensor material and a resulting decrease in resistance. The microstructural properties of the film have a significant impact on sensing performance. The grain size, film thickness, porosity and heat treatment control the sensor performance. Nanosized materials have a very large surface area which offers more surface/gas interaction thereby enhancing the sensing properties. Sensing measurements on nanostructured WO<sub>3</sub> deposited by thermal evaporation have shown promising performances towards sub-ppm concentrations of NO<sub>2</sub> [4]. Mesoporous nanostructured WO<sub>3</sub> films have shown a high sensitivity to NO<sub>2</sub> even at low concentrations [5]. WO<sub>3</sub> thin films with smaller grain size obtained by rf sputtering have shown enhanced sensitivity to oxidizing gases [6]. Annealing of WO<sub>3</sub> films after deposition has been reported to improve crystallinity and defined grain boundaries in the film [7-9].

The aim of this paper is to investigate the gas sensing performance of thermally evaporated WO<sub>3</sub> films at low operating temperatures by optimizing the physical, chemical and electronic properties of these films.

## II. EXPERIMENTAL METHODS

WO<sub>3</sub> thin films were deposited on silicon substrate (8 mm x 8 mm x 0.5 mm) with interdigitated Pt electrodes using thermal evaporation technique. Tungsten oxide (99.9% purity, 20 μm) was used as evaporation source. Before the deposition, the powder was placed in dessicator to avoid any moisture and decontamination. A bell jar type PVD unit (Varian Coater with AVT Control System, Australia) was used to deposit the WO<sub>3</sub> thin films. The substrates were mounted on a substrate holder which was placed at a distance of 38 cm in line of sight from the evaporation source. Deposition was carried out at 4 x 10<sup>-5</sup> mbar. Powder was deposited onto the substrates at a rate of 35 nm per second. A quartz crystal film thickness monitor was used to control the thickness of films which was restricted to 300 nm.

After the deposition, the films were annealed at 400°C for 2 hours in air to improve the microstructural properties and relieve any thermal stresses in the films.

An NT-MDT P47 Solver Scanning Probe Microscope was used to study the surface morphology of the films. The  $\text{WO}_3$  film surface was scanned by a silicon tip (radius of curvature 10 nm) in semi-contact mode over an area ranging from 500  $\text{nm}^2$  to 2000  $\text{nm}^2$ . The mean grain size and grain distribution and surface roughness were determined by using the Nova NT-MDT Image Analysis Software. A Jeol 1200 TEM was used at an accelerating voltage of 120kV to investigate the shape and size of  $\text{WO}_3$  nanoparticles. Samples were investigated by scratching the film and placing it on TEM grid. GIXRD analysis was performed on PANalytical XPert Pro Multi Purpose Diffractometer (MPD). A  $\text{Cu K}\alpha$  radiation of wavelength 1.540 Å was used. The incident angle was kept at 2° and the  $2\theta$  range was kept between 10° to 85° with a step size of 0.05°. The  $\text{WO}_3$  sensor responses to various concentrations (10-1000 ppm) of hydrogen at various operating temperatures (100°C to 300°C) were measured. Hydrogen was diluted in synthetic air to achieve the desired concentrations. For all the experiments, the total flow was adjusted to 200 sccm. The gas sensing performance of the films to reducing gases such as  $\text{H}_2$  denoted as  $S_{\text{reducing}}$  is defined as the ratio:

$$S_{\text{reducing}} = \frac{R_{\text{air}} - R_{\text{gas}}}{R_{\text{gas}}} \times 100 \quad (1)$$

where  $R_{\text{air}}$  is the resistance in air under stationary conditions and  $R_{\text{gas}}$  represents the resistance after the sensor is exposed to the target gas during a definite time. Equation 1 can be applied for n-type material such as  $\text{WO}_3$  and reducing gas such as  $\text{H}_2$ .

The response curve was recorded under a continuous flow of known amount of  $\text{H}_2$ . A sequence control computer was utilized to computerize the pulse sequence of the  $\text{H}_2$  concentrations. Initially, synthetic air was passed through the chamber at testing temperature until the stable baseline resistance was observed. Then a sequence of target gas pulse was generated for 10 minutes followed by synthetic air pulse. This procedure was continued until a stable baseline was observed after alternate pulses. This was followed by the experimental sequence of pulses and data was recorded. Each sensor was tested at temperatures between 100°C to 300°C at intervals of 50°C under various concentrations of  $\text{H}_2$ , and optimum operating temperature was determined. This was followed by two full range tests for each sensor and  $\text{H}_2$  at the optimum operating temperature.

### III. RESULTS AND DISCUSSIONS

The surface topography of as-deposited  $\text{WO}_3$  film is shown in Figure 1. The mean particle size and roughness were found to be 13 nm and 0.5 nm respectively, as determined from Nova NT-MDT Image Analysis Software. Upon annealing at 400°C for 2 hours in air, a very grain size (5 nm) and porous structure are observed (Figure 2). It appears that the as-deposited  $\text{WO}_3$  film is made up of cluster of small particles. The nucleation and successive grain growth as a result of annealing at 400°C for 2 hours in air transformed these particles into very fine grains and well defined grain boundaries.

Figure 3 shows the GIXRD patterns of as-deposited and annealed  $\text{WO}_3$  films. The as-deposited film did not show any diffraction pattern, which indicates that as-deposited film is highly amorphous. However, after annealing at 400°C, significant crystallinity is observed in the films, indicated by appearance of diffraction peaks in GIXRD pattern. The peaks obtained at  $2\theta = 24.112^\circ, 28.538^\circ, 34.361^\circ, 41.615^\circ, 49.843^\circ, 55.684^\circ, 61.941^\circ$  are closely related to monoclinic  $\text{WO}_3$  phase [10]. It should be noted that the lattice parameters of orthorhombic  $\text{WO}_3$  phase are very similar to monoclinic phase,

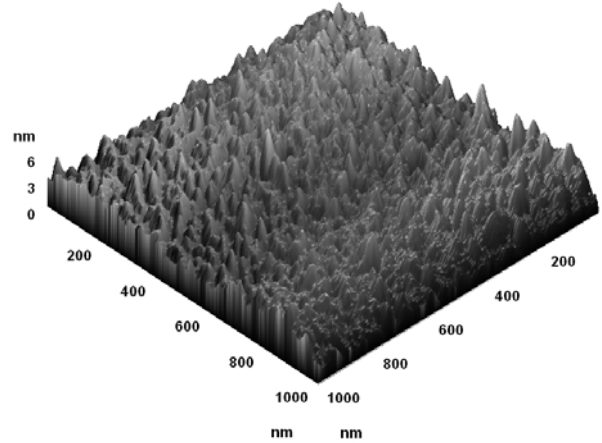


Figure 1. AFM topography image of as-deposited nanostructured  $\text{WO}_3$  thin film.

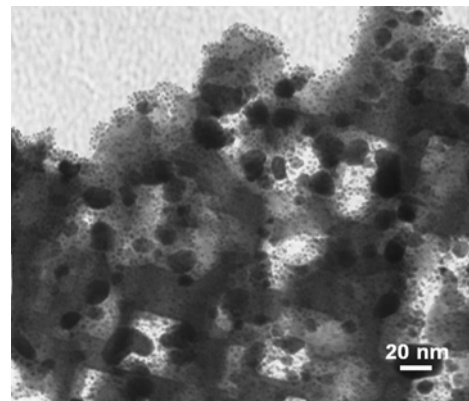


Figure 2. TEM image of nanostructured  $\text{WO}_3$  thin film annealed at 400°C for 2 hours in air.

and thus, these two phases cannot be distinguished within the accuracy of GIXRD data. It has been reported that the two intense peaks observed at  $2\theta=24.278^\circ$  and  $34.117^\circ$  are associated to (2 0 0) and (2 2 0) monoclinic planes of  $\text{WO}_3$  corresponding to  $d=3.663^\circ$  and 2.626 Å, respectively [11]. The lattice parameters were found to be  $a = 7.375 \text{ \AA}$ ,  $b = 7.375 \text{ \AA}$  and  $c = 3.903 \text{ \AA}$  and its unit cell volume is about  $212.38 \text{ \AA}^3$ .

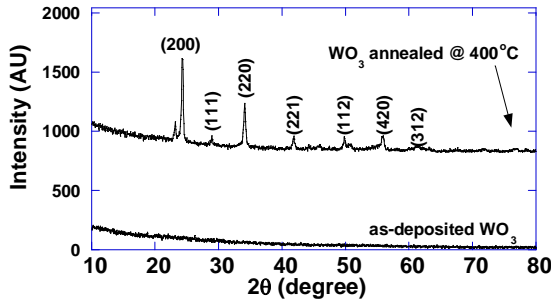


Figure 3. GIXRD spectra of as-deposited and annealed WO<sub>3</sub> thin films.

The Raman spectra of as-deposited and 400°C annealed films are shown in Figure 4. Two characteristic Raman bands are associated with WO<sub>3</sub>. The first band lies between 200-500 cm<sup>-1</sup> and is associated with O-W-O bending vibration modes. The second band lies in the range 600-1000 cm<sup>-1</sup> and is associated with W-O stretching vibration modes. The as-deposited WO<sub>3</sub> film exhibited weak and broad Raman bands centred at 315 cm<sup>-1</sup> and 799 cm<sup>-1</sup>. These features are characteristic of amorphous materials and are usually assigned to O-W-O deformation modes and O-W-O stretching vibration modes of monoclinic WO<sub>3</sub> phase, respectively [12]. This is in accordance with the GIXRD observations. However, crystallinity of the WO<sub>3</sub> increased after annealing at 400°C, as shown by sharp peaks at 707 cm<sup>-1</sup> and 799 cm<sup>-1</sup> which are characteristic of O-W-O stretching vibration modes [13]. Raman results indicate that the annealed films are highly crystalline, which is also supported by GIXRD observations.

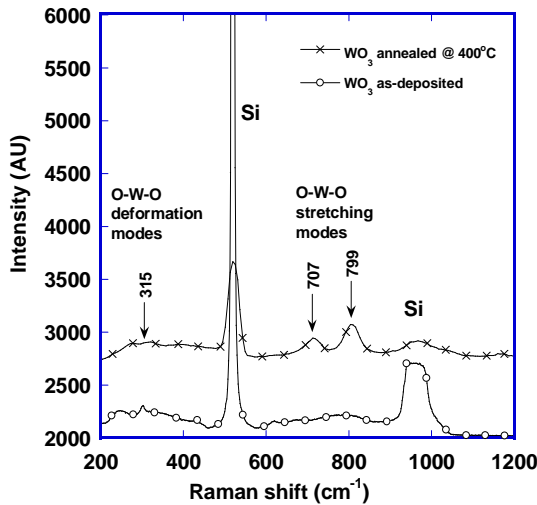


Figure 4. Raman spectra of as-deposited and annealed WO<sub>3</sub> thin films.

The as-deposited films did not show any response towards H<sub>2</sub> in the selected temperature range. It has been shown experimentally that amorphous films have poor sensor

response characteristics [14]. The amorphous nature of the as-deposited films seems to lead these films being not suitable for gas sensing. When the film is annealed at 400°C, an optimum response is obtained at an operating temperature of 150°C (Fig. 5). A high sensitivity S=10 to 10,000 ppm H<sub>2</sub> is observed. The response and recovery time to 10000 ppm H<sub>2</sub> are 140 s and 80 s at 150°C.

WO<sub>3</sub> is an n-type semiconductor material and commonly operates as a gas sensor in the temperature between 200°C - 500°C [15]. When it is exposed to a reducing gas such as H<sub>2</sub>, the oxygen adsorbates on the film surface interact with the gas and release electrons back to the film, causing a drop in film resistance. However, the opposite behaviour (i.e. an increase in resistance) is observed for the 400°C annealed WO<sub>3</sub> film upon exposure to H<sub>2</sub> at 150°C. Such behaviour cannot be explained by merely considering the microstructural properties such as grain size and porosity of the film.

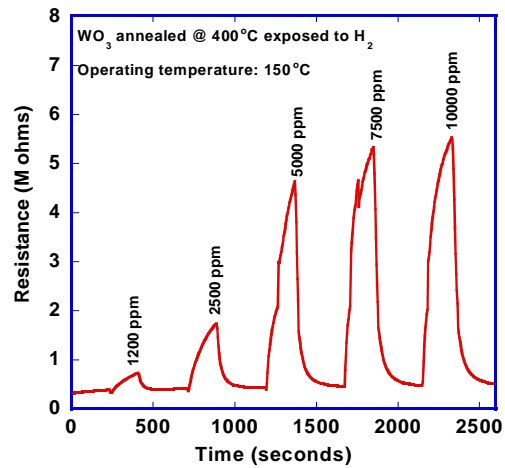


Figure 5. Dynamic response of 400°C annealed WO<sub>3</sub> thin film upon exposure to H<sub>2</sub> at 150°C.

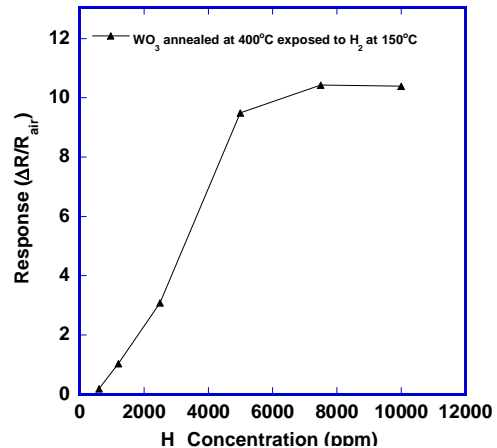
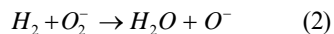


Figure 6. Response amplitude of 400°C annealed WO<sub>3</sub> film upon exposure to H<sub>2</sub> at 150°C.

In polycrystalline materials, surface barriers which electrons have to overcome for taking part in the conduction are formed at the intergranular surfaces. The height of surface barrier depends on the concentration of charge carriers (oxygen adsorbates) at the surface, and, therefore, overall resistance changes can be correlated with changes in surface band bending. The overall resistance, and, hence, surface band bending increased exponentially when the polycrystalline WO<sub>3</sub> surface was exposed to increasing concentrations of oxygen [16]. The increase in resistance observed for the 400°C annealed WO<sub>3</sub> film exposed to H<sub>2</sub> at an operating temperature of 150°C might arise from various forms of oxygen adsorbates (O<sup>-</sup>, O<sup>2-</sup> and O<sub>2</sub><sup>-</sup>) on WO<sub>3</sub> surface, which depend on temperature. At 150°C, the most dominant form of adsorbed oxygen is O<sub>2</sub><sup>-</sup> [17]. Upon exposure to H<sub>2</sub>, the O<sub>2</sub><sup>-</sup> species dissociates into O<sup>-</sup> with the formation of water, as per the following equation.



*In situ* Raman analysis of WO<sub>3</sub> films annealed at 300°C and 400°C has shown that the rate of water desorption above 100°C is much faster than the rate of water formation on the film surface when WO<sub>3</sub> film is exposed to H<sub>2</sub> [18]. At 150°C, the high concentration range of H<sub>2</sub> (600 ppm – 10000 ppm) produces more O<sup>-</sup> species on the surface, leading to increase in surface barrier height, consequently increasing the resistance. Hence, this can be a reason why an increase in resistance was observed at lower operating temperature. The high sensitivity to H<sub>2</sub> at 150°C observed for the 400°C annealed WO<sub>3</sub> film is attributed to its very small grain size (5 nm), porous structure and high crystallinity.

#### IV. CONCLUSIONS

Nanostructured WO<sub>3</sub> thin films have been deposited using thermal evaporation technique. The as-deposited films are highly amorphous and made up of cluster of particles. Annealing these films at 400°C for 2 hours in air improved the crystalline and transformed these clusters into very small grains of 5 nm size and a porous structure. The GIXRD and Raman analysis show that annealing improves the crystallinity of these films. The annealed WO<sub>3</sub> film shows a high response to various concentrations of H<sub>2</sub> at a relatively low temperature of 150°C. The response to hydrogen is mainly attributed to the very small grain size, porous structure and high crystallinity achieved by heat treatment.

#### ACKNOWLEDGMENT

The authors would like to thank Queensland University of Technology for their support. The first author is thankful to RMIT University for using its gas sensor testing facility.

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